

Chapter 3.2

Energy

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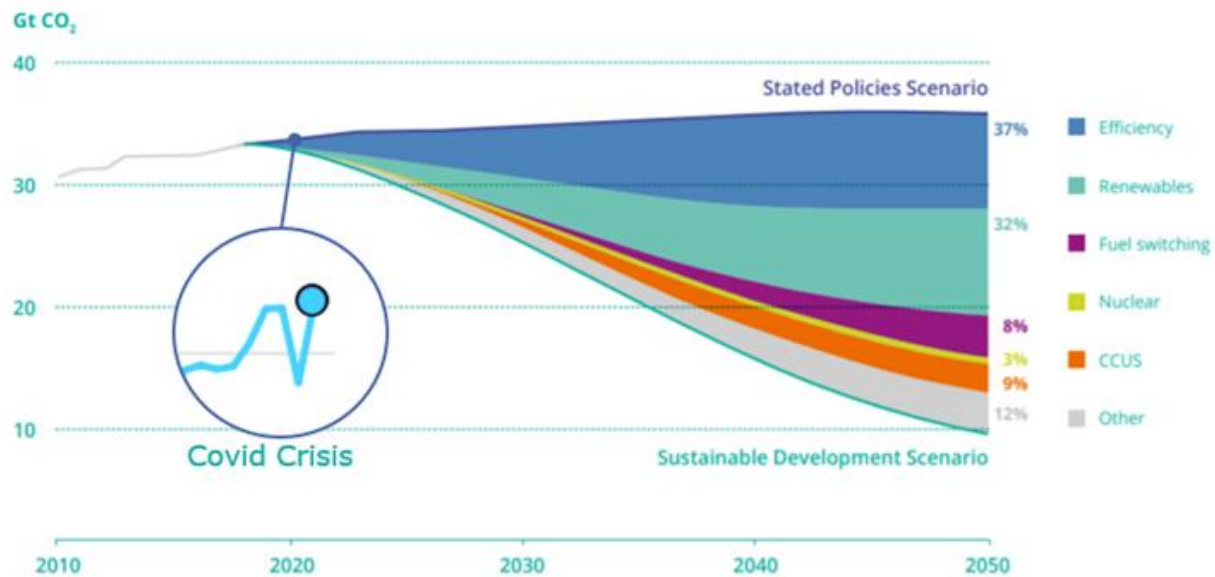
*Strategic Research and
Innovation Agenda 2025*



Scope

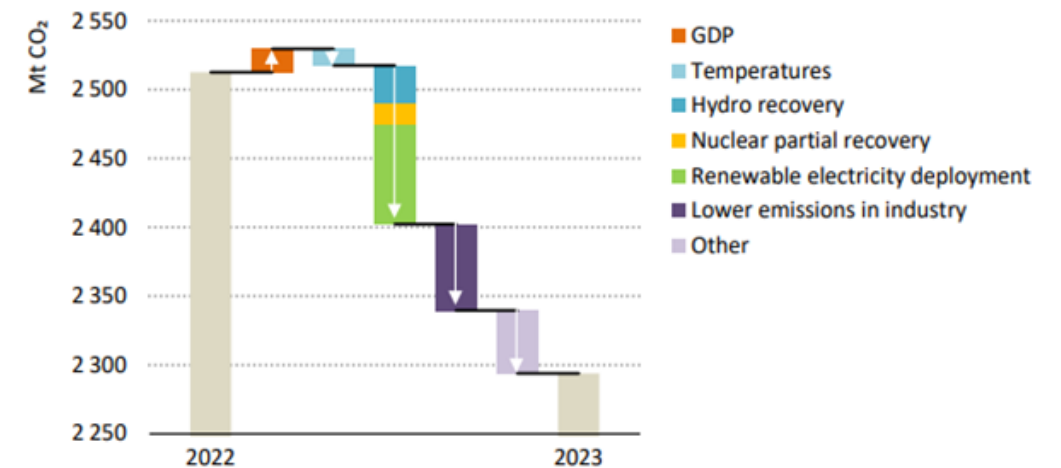
Electronic components and systems (ECS) are key to future energy systems being optimised in both design and operation, for high efficiency, substitution to zero emission technologies, low CO₂-emissions, cost, and security of supply.

ENERGY-RELATED CO₂ EMISSIONS AND REDUCTIONS BY SOURCE IN THE SUSTAINABLE DEVELOPMENT SCENARIO



Source: IEA Global Energy Review: CO₂ Emissions in 2021

Figure 9: Change in total CO₂ emissions from combustion in the European Union by driver, 2022-2023



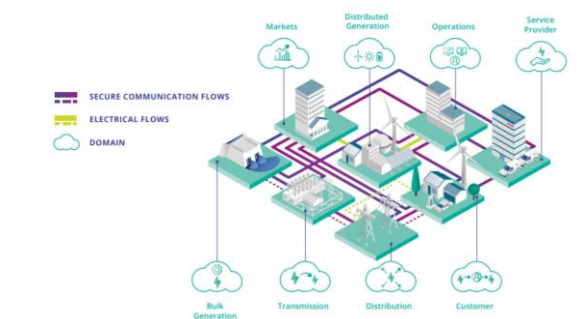
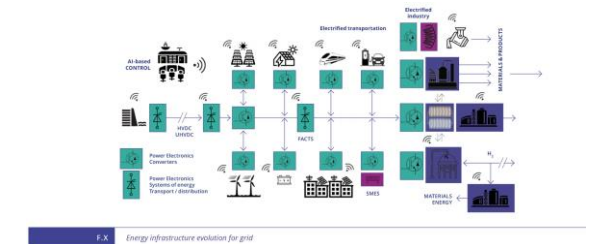
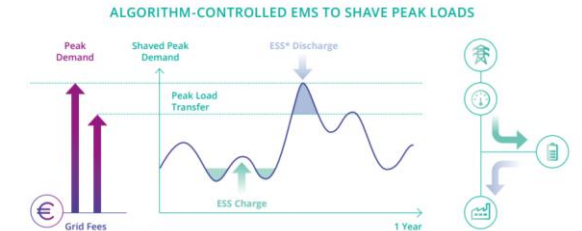
IEA. CC BY 4.0.

Source: IEA – CO₂ emissions in 2023: A new record high, but is there light at the end of the tunnel?

Major challenges



- **Major Challenge 1:** Smart & Efficient - Managing **Renewable** Generation, **Energy** Conversion, and Storage Systems.
- **Major Challenge 2:** Energy Management from On-Site to Distribution Systems.
- **Major Challenge 3:** Future **Distribution &** Transmission Grids.
- **Major Challenge 4:** Achieving Clean, Efficient & Resilient Urban/Regional Energy Supply.
- **Major Challenge 5:** Cross-Sectional Tasks for Energy System Monitoring & Control.



Key trends

- Affordability of the transition towards net zero emissions
- Increased efficiency & digitalization at all levels
- Residential, commercial, and industrial demand side management - scheduling and load adaption
- Conversion to zero emission technologies
- Security, reliability and stability of total energy system
- Hybrid solutions
- Grid stability & trans EU solutions
- Self-adaptive control based on Artificial Intelligence / Machine Learning
- Flexibility in management of energy supply
- IT security, connectivity, integrity

Application needs **translate into ECS technologies:**

- Power semiconductors, wide band gap
- Multi technology solutions, modularity
- Sustainable manufacturing, use of materials
- Design technologies
- Reliability, heterogenous integration
- Digital control, sensors
- Digital actuators, switches, substitution of fuses
- Real time low latency reaction
- Data integrity and privacy
- System solutions and interfaces for seamless integration...

R&I focus areas

- Power semiconductors, wide band gap
- Multi technology solutions, modularity
- Sustainable manufacturing, use of materials
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- Reliability, heterogenous integration
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